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FAIRCHILD

60V N-Channel PowerTrench[®] MOSFET

General Description

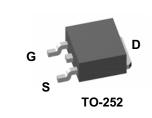
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $R_{DS(ON)}$ and fast switching speed. extremely low $R_{DS(ON)}$ in a small package.

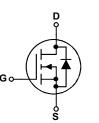
Applications

- DC/DC converter
- Motor drives

Features

- 52 A, 60 V $R_{DS(ON)} = 15 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$ $R_{DS(ON)} = 18 \text{ m}\Omega @ V_{GS} = 6 \text{ V}$
- Low gate charge
- Fast switching
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$





Absolute Maximum Ratings TA=25°C unless otherwise noted

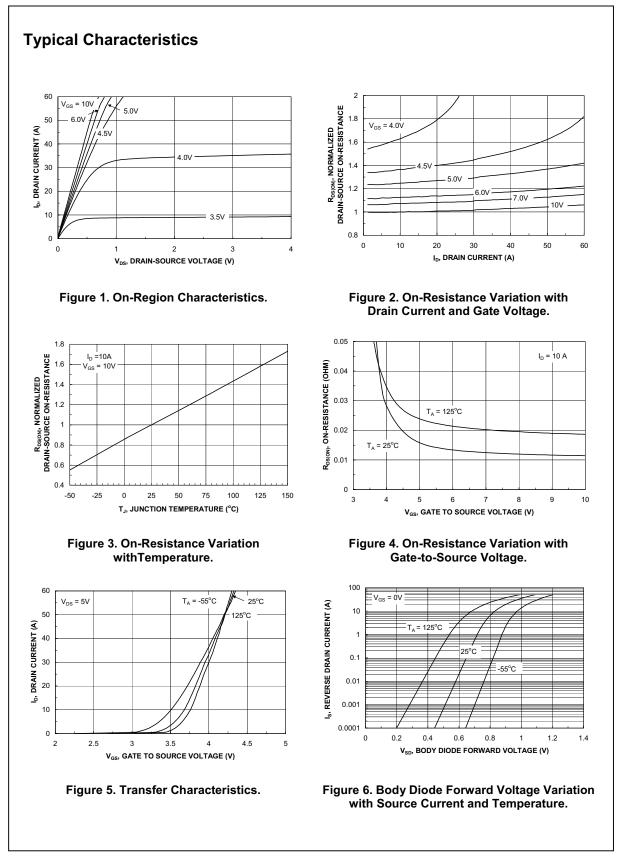
Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		60	V
V _{GSS}	Gate-Source Voltage		±20	V
I _D	Drain Current – Continuous	(Note 3)	52	A
	– Pulsed	(Note 1a)	150	
PD	Power Dissipation for Single Operation	(Note 1)	83	W
		(Note 1a)	3.8	
		(Note 1b)	1.6	
T _J , T _{STG}	Operating and Storage Junction Temperate	ure Range	-55 to +175	°C
Therma	I Characteristics			
R _{θJC}	Thermal Resistance, Junction-to-Case	(Note 1)	1.8	°C/W
$R_{ ext{ hetaJA}}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	40	°C/W
R _{0JA}	Thermal Resistance, Junction-to-Ambient	(Note 1b)	96	°C/W

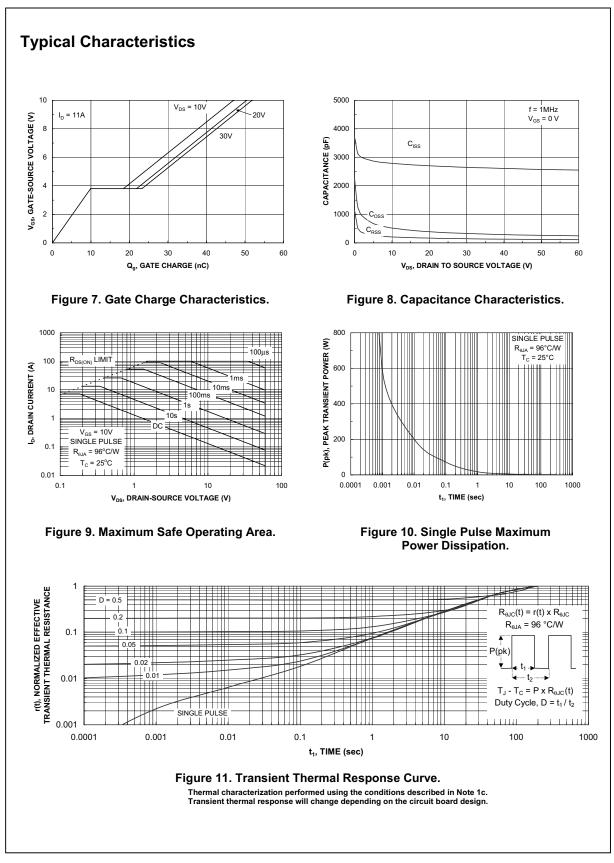
Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
FDD5670	FDD5670	13"	16mm	2500 units

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-So	ource Avalanche Ratings (Note	2)				
N _{DSS}	Drain-Source Avalanche Energy	Single Pulse, V_{DD} = 20 V, I_D = 10A			360	mJ
AR	Drain-Source Avalanche Current				10	Α
Off Char	acteristics	•				
3V _{DSS}	Drain–Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	60			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		53		mV/°C
DSS	Zero Gate Voltage Drain Current	V _{DS} = 48 V, V _{GS} = 0 V			1	μA
GSSF	Gate–Body Leakage, Forward	V _{GS} = 20 V, V _{DS} = 0 V			100	nA
GSSR	Gate–Body Leakage, Reverse	$V_{GS} = -20 V$, $V_{DS} = 0 V$		Ī	-100	nA
On Char	acteristics (Note 2)	·		•		
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	2	2.5	4	V
<u>ΔV_{GS(th)}</u> ΔT _J	Gate Threshold Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		-6		mV/°C
RDS(on)	Static Drain–Source On–Resistance	$V_{GS} = 10 V$, $I_D = 10 A$ $V_{GS} = 6 V$, $I_D = 9 A$ $V_{GS} = 10 V$, $I_D = 10 A$, $T_J = 125^{\circ}C$		12 14 19	15 18 26	mΩ
D(on)	On–State Drain Current		60			A
J FS	Forward Transconductance	$V_{DS} = 5 V$, $I_{D} = 10 A$		27		S
Dvnamic	Characteristics					,
Ciss	Input Capacitance	$V_{DS} = 15 V$, $V_{GS} = 0 V$,		2739		pF
Coss	Output Capacitance	f = 1.0 MHz		441		pF
Crss	Reverse Transfer Capacitance	1		182		, pF
	g Characteristics (Note 2)	1				
d(on)	Turn–On Delay Time	$V_{DD} = 30 V$, $I_D = 1 A$,		20	32	ns
	Turn–On Rise Time	$V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		12	24	ns
d(off)	Turn–Off Delay Time	1		60	95	ns
.f	Turn–Off Fall Time			24	38	ns
, Q ^a	Total Gate Charge	$V_{DS} = 15 V$, $I_{D} = 10 A$,		52	73	nC
Q _{gs}	Gate–Source Charge	V _{GS} = 10 V		10	-	nC
\mathbf{Q}_{gd}	Gate–Drain Charge	1		13		nC
•	ource Diode Characteristics	and Maximum Patings	1		1	-
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = 3.5 A$ (Note 2)		0.74	1.2	V
	n of the junction-to-case and case-to-ambient then $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is detern	nined by the user's board design. V when mounted on a box copper	b) R _{eJA}	= 96°C/W minimum p	when mou	









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